

Li-lon BATTERY PROTECTOR **R5421NxxxC/xxxF series**

OUTLINE

The R5421NxxxC/F Series are protection ICs for over-charge/discharge of rechargeable one-cell Lithium-ion (Li+) excess load current, further include a short circuit protector for preventing large external short circuit current.

Each of these ICs is composed of three voltage detectors, a reference unit, a delay circuit, a short circuit protector, and a logic circuit. When charging voltage crosses the detector threshold from a low value to a value higher than V_{DET1}, the output of C_{OUT} pin, the output of over-charge detector/VD1, switches to low level, charger's negative pin level. After detecting over-charge the VD1 can be reset and the output of C_{OUT} becomes high when the V_{DD} voltage is coming down to a level lower than "V_{REL1}", or when a kind of loading is connected to V_{DD} after a charger is disconnected from the battery pack while the V_{DD} level is in between "V_{DET1}" and "V_{REL1}" in the R5421NxxxC/F version.

The output of Dout pin, the output of over-discharge detector/VD2, switches to low level after internally fixed delay time passed, when discharging voltage crosses the detector threshold from a high value to a value lower than VDET2. After R5421NxxxC/F Series detect the over-discharge voltage, connect a charger to the battery pack, and when the battery supply voltage becomes higher than the over-discharge detector threshold, VD2 is released and the voltage of Dout becomes "H" level. In the case of F version, after detecting the over-discharge detection, when the battery supply voltage becomes equal or higher than over-discharge released voltage, VD2 is also released by the condition, and the voltage of Dout becomes "H" level.

An excess load current can be sensed and cut off after internally fixed delay time passed through the built in excess current detector, VD3, with Dout being enabled to low level. Once after detecting excess current, the VD3 is released and Dout level switches to high by detaching a battery pack from a load system.

Further, short circuit protector makes Dout level to low immediately with external short circuit current and removing external short circuit leads Dout level to high. After detecting over-discharge, supply current will be kept extremely low by halt some internal circuits operation. The output delay of over-charge detectors can be set by connecting external capacitors. Output type of Cout and Dout are CMOS. 6-pin, SOT23-6 is available.

■ FEATURES

•	Low supply current	Supply current Standby current (detecting over-disch	arge)	Typ. 3.0µA Typ. 0.3µA (for R5421NxxxC) Typ. 1.0µA (for R5421NxxxF)
•	High accuracy detector threshold	· 1	1)	±25mV
		(Topt=0 to 50°C) Over-discharge detector	·)	±30 mV ±2.5%
•	Variety of detector threshold	C	4 0V - 4	4V step of 0.005V
_	variety of detector threshold	Over-discharge detector threshold		0V step of 0.005V
•	Built-in protection circuit	C		0.4V step of 0.005V
	1	Accuracy		±15%
•	Output delay of over-charge	Time delay at C3=0.01µF and VDD=4.	3V	
			75ms for	R5421N111C
•	Output delay of over-discharge	VDD=2.4V with built-in capacitor		
			10ms for	R5421N111C/112C
•	Small package	SOT-23-6 / 6-pin		

■ APPLICATIONS

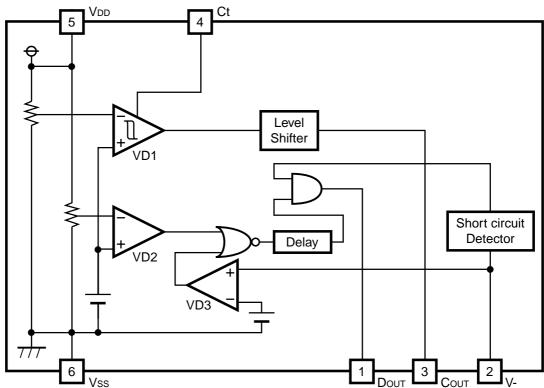
- Li+ one-cell protector for battery pack
- High precision protectors for cell-phones and any other gadgets using on board Li+ one-cell battery

RIGOH

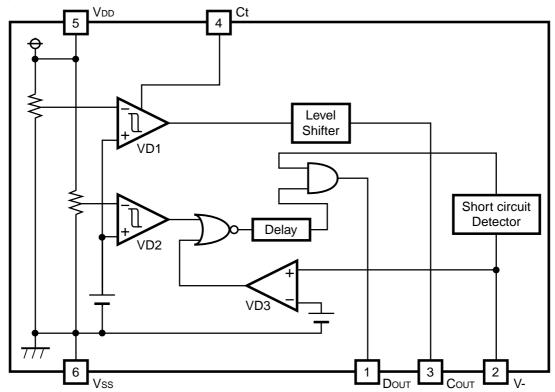
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■ BLOCK DIAGRAM

• R5421NxxxC



• R5421NxxxF



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■ SELECTION GUIDE

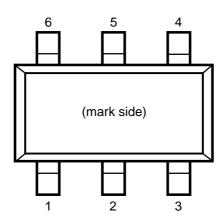
In the R5421Nxxxx Series three of the input threshold for over-charge, over-discharge and excess current detectors can be designated.

Part Number is designated as follows:

R5421N
$$\underline{XXX}X$$
- \underline{XX} \leftarrow Part Number
$$\uparrow \uparrow \uparrow \uparrow$$
a b c

Code	Description		
0	Serial Number for the R5421N Series designating input threshold for over-charge, over-discharge		
a	and excess current detectors as well as hysteresis range for over-charge detector.		
b Designation of version symbols c Taping Type: TR (refer to Taping Specification)			

■ PIN CONFIGURATION



■ PIN DESCRIPTION

Pin No. Symbol		Pin description		
1	Dout	Output of over-discharge		
1	DOUT	detection, CMOS output		
2	V-	Pin for charger negative input		
2	Соит	Output of over-charge		
3		detection, CMOS output		
4	Ct	Pin for external capacitor		
4		setting output delay of VD1		
5	$V_{ m DD}$	Power supply		
6	Vss	Ground		

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■ ABSOLUTE MAXIMUM RATINGS

Vss=0V

Symbol	Item	Ratings	Unit
$V_{ m DD}$	Supply voltage	-0.3 to 12	V
	Input Voltage		
V-	V - pin	$V_{\rm DD}$ -28 to $V_{\rm DD}$ +0.3	V
VCt	Ct pin	V_{SS} -0.3 to V_{DD} +0.3	V
	Output voltage		
VCout	Cout pin	$V_{\rm DD}$ -28 to $V_{\rm DD}$ +0.3	V
VDout	Dout pin	V_{SS} -0.3 to V_{DD} +0.3	V
PD	Power dissipation	150	mW
Topt	Operating temperature	-40 to 85	°C
Торі	range	-40 to 65	
Tstg	Storage temperature range	-55 to 125	°C

ABSOLUTE MAXIMUM RATINGS

Absolute Maximum ratings are threshold limit values that must not be exceeded ever for an instant under any conditions. Moreover, such values for any two items must not be reached simultaneously. Operation above these absolute maximum ratings may cause degradation or permanent damage to the device. These are stress ratings only and do not necessarily imply functional operation below these limits.

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■ ELECTRICAL CHARACTERISTIC

● R5421N111C Topt=25°C

Symbol	Item	Conditions	MIN.	TYP.	MAX.	Unit
V_{DD1}	Operating input voltage	Voltage defined as VDD - Vss	1.5		10	V
Vst	Minimum operating Voltage for 0V charging	Voltage defined as V _{DD} - V-, V _{DD} - V _{SS} =0V			1.2	V
V _{DET1}	Over-charge threshold	Detect rising edge of supply voltage				
		(Topt=25°C)	4.225	4.250	4.275	V
		(Topt=0 to 50°C)*Note	4.220	4.250	4.280	V
V _{REL1}	Release voltage for over- charge detection		4.00	4.05	4.10	V
tVdeti	Output delay of over- Charge	C3=0.01µF, Vdd=3.6V to 4.3V	60	75	90	ms
V _{DET2}	Over-discharge threshold	Detect falling edge of supply voltage	2.437	2.500	2.563	V
tV _{DET2}	Output delay of over- Discharge	V _{DD} =3.6V to 2.4V	7	10	13	ms
V _{DET3}	Excess current threshold	Detect rising edge of 'V-' pin voltage	0.17	0.20	0.23	V
tVDET3	Output delay of excess Current	VDD=3.0V	9	13	17	ms
Vshort	Short protection voltage	V _{DD} =3.0V	V _{DD} -1.2	V _{DD} -0.9	V _{DD} -0.6	V
tshort	Output Delay of Short protection	V _{DD} =3.0V		5	50	μs
Rshort	Reset resistance for Excess current protection	V _{DD} =3.6V, V-=1.0V	50	100	150	kΩ
Vol1	Nch ON voltage of Cout	Iol=50μA, V _{DD} =4.4V		0.35	0.5	V
Voh1	Pch ON voltage of Cout	Ioh=-50μA, V _{DD} =3.9V	3.4	3.7		V
Vol2	Nch ON voltage of Dout	Iol=50μA, V _{DD} =2.4V		0.2	0.5	V
Voh2	Pch ON voltage of Dout	Ioh=-50μA, V _{DD} =3.9V	3.4	3.7		V
Idd	Supply current	$V_{DD}=3.9V, V_{-}=0V$		3.0	6.0	μA
Istandby	Standby current	$V_{DD}=2.0V$		0.3	0.6	μA

^{*}Note: Considering of variation in process parameters, we compensate for this characteristic related to temperature by laser-trim, however, this specification is guaranteed by design, not production tested.

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● R5421N112C Topt=25°C

Symbol	Item	Conditions	MIN.	TYP.	MAX.	Unit
V _{DD1}	Operating input voltage	Voltage defined as VDD - Vss	1.5		10	V
Vst	Minimum operating Voltage for 0V charging	Voltage defined as V _{DD} - V-, V _{DD} - V _{SS} =0V			1.2	V
V_{DET1}	Over-charge threshold	Detect rising edge of supply				
		Voltage				
		Topt=25°C	4.325	4.350	4.375	V
		Topt=0 to 50°C*Note	4.320	4.350	4.380	V
V _{REL1}	Release voltage for over- charge detection		4.100	4.150	4.200	V
tVdeti	Output delay of over- Charge	C3=0.01µF, Vdd=3.6V to 4.4V	61	77	93	ms
V _{DET2}	Over-discharge threshold	Detect falling edge of supply Voltage	2.437	2.500	2.563	V
tV _{DET2}	Output delay of over- Discharge	V _{DD} =3.6V to 2.4V	7	10	13	ms
V _{DET3}	Excess current threshold	Detect rising edge of 'V-' pin Voltage	0.17	0.20	0.23	V
tV _{DET3}	Output delay of excess Current	V _{DD} =3.0V	9	13	17	ms
Vshort	Short protection voltage	V _{DD} =3.0V	V _{DD} -1.2	V _{DD} -0.9	V _{DD} -0.6	V
tshort	Output Delay of Short protection	V _{DD} =3.0V		5	50	μs
Rshort	Reset resistance for excess current protection	V _{DD} =3.6V, V-=1.0V	50	100	150	kΩ
Vol1	Nch ON voltage of Cout	Iol=50μA, V _{DD} =4.4V		0.35	0.5	V
Voh1	Pch ON voltage of Cout	Ioh=-50μA, V _{DD} =3.9V	3.4	3.7		V
Vol2	Nch ON voltage of Dout	Iol=50μA, V _{DD} =2.4V		0.2	0.5	V
Voh2	Pch ON voltage of Dout	Ioh=-50μA, V _{DD} =3.9V	3.4	3.7		V
Idd	Supply current	V _{DD} =3.9V,V-=0V		3.0	6.0	μΑ
Istandby	Standby current	V _{DD} =2.0V		0.3	0.6	μA

Istandby Standby current V_{DD}=2.0V 0.3 0.6 μA
*Note: Considering of variation in process parameters, we compensate for this characteristic related to temperature by laser-trim, however this specification is guaranteed by design, not production tested.

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• R5421N151F Topt=25°C

Symbol	Item	Conditions	MIN.	TYP.	MAX.	Unit
V_{DD1}	Operating input voltage	Voltage defined as VDD - Vss	1.5		10	V
Vst	Minimum operating Voltage for 0V charging	Voltage defined as V _{DD} - V-, V _{DD} - V _{SS} =0V			1.2	V
V_{DET1}	Over-charge threshold	Detect rising edge of supply				
		Voltage				
		Topt=25°C	4.225	4.250	4.275	V
		Topt=0 to 50°C*Note	4.220	4.250	4.280	V
V _{REL1}	Release voltage for over- charge detection		4.000	4.050	4.100	V
	Output delay of over-					
tV _{DET1}	Charge	$C3=0.01\mu F$, $V_{DD}=3.6V$ to $4.3V$	60	75	90	ms
V _{DET2}	Over-discharge threshold	Detect falling edge of supply	2.437	2.500	2.563	V
	Output dalam of accord	Voltage				
tV _{DET2}	Output delay of over- Discharge	V _{DD} =3.6V to 2.4V	7	10	13	ms
V _{DET3}	Excess current threshold	Detect rising edge of 'V-' pin Voltage	0.17	0.20	0.23	V
tV _{DET3}	Output delay of excess Current	V _{DD} =3.0V	9	13	17	ms
Vshort	Short protection voltage	V _{DD} =3.0V	V _{DD} -1.2	V _{DD} -0.9	V _{DD} -0.6	V
tshort	Output Delay of Short protection	V _{DD} =3.0V		5	50	μs
Rshort	Reset resistance for excess current protection	V _{DD} =3.6V, V-=1.0V	50	100	150	kΩ
Vol1	Nch ON voltage of Cout	Iol=50μA, V _{DD} =4.4V		0.35	0.5	V
Voh1	Pch ON voltage of Cout	Ioh=-50μA, V _{DD} =3.9V	3.4	3.7		V
Vol2	Nch ON voltage of Dout	Iol=50μA, V _{DD} =2.2V		0.2	0.5	V
Voh2	Pch ON voltage of Dout	Ioh=-50μA, V _{DD} =3.9V	3.4	3.7		V
Idd	Supply current	$V_{DD}=3.9V, V_{-}=0V$		3.0	6.0	μA
Istandby	Standby current	V _{DD} =2.0V		1.0	2.0	μA

Istandby | Standby current | V_{DD}=2.0V | 1.0 | 2.0 | μA *Note: Considering of variation in process parameters, we compensate for this characteristic related to temperature by laser-trim, however, this specification is guaranteed by design, not production tested.

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● R5421N152F Topt=25°C

Symbol	Item	Conditions	MIN.	TYP.	MAX.	Unit
V _{DD1}	Operating input voltage	Voltage defined as V _{DD} - V _{SS}	1.5	_	10	V
Vst	Minimum operating Voltage for 0V charging	Voltage defined as V _{DD} - V-, V _{DD} - V _{SS} =0V			1.2	V
V _{DET1}	Over-charge threshold	Detect rising edge of supply				
		Voltage				
		Topt=25°C	4.325	4.350	4.375	V
		Topt=0 to 50°C*Note	4.320	4.350	4.380	V
V_{REL1}	Release voltage for over- charge detection		4.100	4.150	4.200	V
tV _{DET1}	Output delay of over- Charge	C3=0.01µF, V _{DD} =3.6V to 4.4V	61	77	93	ms
V _{DET2}	Over-discharge threshold	Detect falling edge of supply Voltage	2.437	2.500	2.563	V
tV _{DET2}	Output delay of over- Discharge	V _{DD} =3.6V to 2.4V	7	10	13	ms
V _{DET3}	Excess current threshold	Detect rising edge of 'V-' pin Voltage	0.17	0.20	0.23	V
tV _{DET3}	Output delay of excess Current	V _{DD} =3.0V	9	13	17	ms
Vshort	Short protection voltage	V _{DD} =3.0V	V _{DD} -1.2	V _{DD} -0.9	V _{DD} -0.6	V
tshort	Output Delay of Short protection	V _{DD} =3.0V		5	50	μs
Rshort	Reset resistance for excess current protection	V _{DD} =3.6V, V-=1.0V	50	100	150	kΩ
Vol1	Nch ON voltage of Cout	Iol=50μA, V _{DD} =4.4V		0.35	0.5	V
Voh1	Pch ON voltage of Cout	Ioh=-50μA, V _{DD} =3.9V	3.4	3.7		V
Vol2	Nch ON voltage of Dout	Iol=50μA, Vdd=2.2V		0.2	0.5	V
Voh2	Pch ON voltage of Dout	Ioh=-50μA, V _{DD} =3.9V	3.4	3.7		V
Idd	Supply current	V _{DD} =3.9V,V-=0V		3.0	6.0	μA
Istandby	Standby current	V _{DD} =2.0V		1.0	2.0	μA

IstandbyStandby currentVDD=2.0V1.02.0μA*Note: Considering of variation in process parameters, we compensate for this characteristic related to temperature by laser-trim, however, this specification is guaranteed by design, not production tested.

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OPERATION

VD1 / Over-Charge Detector in the 'C' version

The VD1 monitors V_{DD} pin voltage. When the V_{DD} voltage crosses over-charge detector threshold V_{DET1} from a low value to a value higher than the V_{DET1}, the VD1 can sense a over-charging and an external charge control Nch-MOS-FET turns to "OFF" with C_{OUT} pin being at "Low" level.

There can be two cases to reset the VD1 making the Cout pin level to "High" again after detecting over-charge. Resetting the VD1 can make charging system allowable to resumption of charging process.

The first case is in such conditions that a time when the V_{DD} voltage is coming down to a level lower than "V_{REL1}". While in the second case, connecting a kind of loading to V_{DD} after disconnecting a charger from the battery pack can make the V_{DD} level is in between "V_{DET1}" and "V_{REL1}".

After detecting over-charge with the V_{DD} voltage of higher than V_{DETI} , connecting system load to the battery pack makes load current allowable through parasitic diode of external charge control FET.

The Cout level would be High when the VDD level is coming down to a level below the VDET1 by continuous drawing of load current.

An output delay time for over-charge detection can be set by external capacitor C3 connecting between the Vss pin and Ct pin. The external capacitor can make a delay time from a moment detecting over-charge to a time output a signal which enables charge control FET turn to "OFF".

When the V_{DD} level is going up to a higher level than V_{DET1} if the V_{DD} voltage would be back to a level lower than the V_{DET1} within a time period of the output delay time, VD1 would not output a signal for turning "OFF" of charge control FET. The output delay time can be calculated as below:

 $tVDETI[sec] = (C3[F] \times (VDD[V]-0.7) / (0.48 \times 10^{-6})$

Note:Topt=25°C V_{DD} value should be after over-charge detection.

A level shifter incorporated in a buffer driver for the Cout pin makes the "Low" level of Cout pin to the V - pin voltage and the "High" level of Cout pin is set to VDD voltage with CMOS buffer.

VD2 / Over-Discharge Detector

The VD2 is monitoring a V_{DD} pin voltage. When the V_{DD} voltage crosses the over-discharge detector threshold V_{DET2} from a high value to a value lower than the V_{DET2}, the VD2 can sense an over-discharging and the external discharge control Nch MOS FET turns to "OFF" with the D_{OUT} pin being at "Low" level.

To reset the VD2 with the Dout pin level being "H" again after detecting over-discharge it is necessary to connect a charger to the battery pack for R5421NxxxC. When the VDD voltage stays under over-discharge detector threshold VDET2 charge current can flow through parasitic diode of external discharge control MOS FET, then after the VDD voltage comes up to a value larger than VDET2, DOUT becomes "H" and discharging process would be able to advance through ON state MOS FET for discharge control.

Connecting a charger to the battery pack makes the Dout level being "H" instantaneously when the VDD voltage is higher than VDET2.

Besides, for R5421NxxxF, when a cell voltage reaches equal or more than over-discharge released voltage, or VREL2, over-discharge condition can be also released

When a cell voltage equals to zero, connecting charger to the battery pack makes the system allowable to charge with higher charge voltage than Vst, 1.2V Max.

An output delay time for the over-discharge detection is fixed internally, $tV_{DET2}=10ms$ typ. at $V_{DD}=2.4V$. When the V_{DD} level is going down to a lower level than V_{DET2} if the V_{DD} voltage would be back to a level higher than the V_{DET2} within a time period of the output delay time, VD2 would not output a signal for turning "OFF" of discharge control FET.

After detection of an over-discharge by VD2, supply current would be reduced to typically $0.3\mu A$ (for R5421NxxxC) or $1.0\mu A$ (for R5421NxxxF) at V_{DD}=2.0V and into standby, only the charger detector is operating.

The output type of Dout pin is CMOS having "H" level of VDD and "L" level of Vss.



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VD3/Excess Current Detector, Short Circuit Protector

Both of the excess current detector and short circuit protector can work when both control FETs are in "ON" state. When the V- pin voltage is going up to a value between the short protection voltage Vshort /VDD and excess current threshold VDET3, the excess current detector operates and further soaring of V- pin voltage higher than Vshort makes the short circuit protector enabled. This leads the external discharge control Nch MOS FET turns to "OFF" with the DOUT pin being at "Low" level.

An output delay time for the excess current detector is internally fixed, 13ms typ. at VDD=3.0V.

A quick recovery of V- pin level from a value between Vshort and V_{DET3} within the delay time keeps the discharge control FET staying "High" state.

When the short circuit protector is enabled, the Dour would be Low and its delay time would be 5µs typ.

The V - pin has a built-in pulled down resistor ,typ.100k Ω , with connecting to the Vss pin.

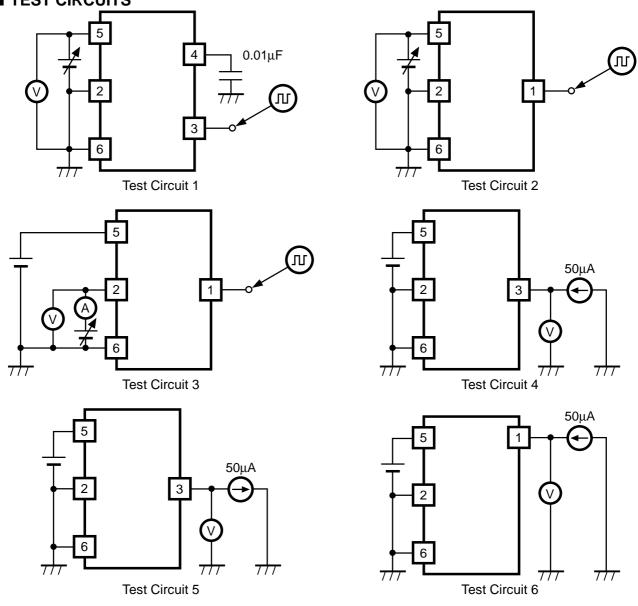
After an excess current or short circuit protection is detected, removing a cause of excess current or external short circuit makes an external discharge control FET to an "ON" state automatically with the V- pin level being down to the Vss level through pulled down resistor built-in internally.

If V_{DD} voltage would be higher than V_{DET2} at a time when the excess current is detected the R5421NxxxC does not enter a standby mode, or otherwise in case of lower V_{DD} voltage than V_{DET2} would lead the R5421NxxxC into a standby. After detecting short circuit the R5421NxxxC will not enter a standby mode.

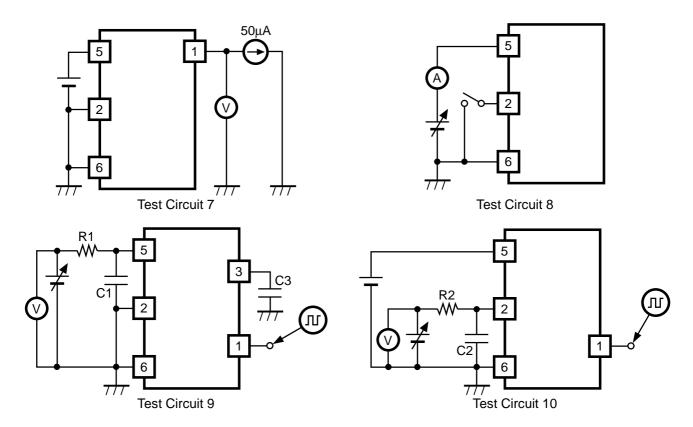


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■ TEST CIRCUITS



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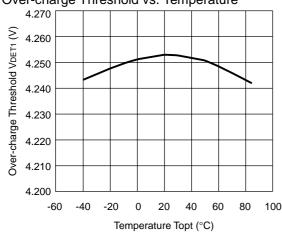
The typical characteristics were obtained by use of these test circuits.

Test Circuit 1 : Typical Characteristics 1) 5) 7) 17) : Typical Characteristics 2) 6) 8) Test Circuit 2 Test Circuit 3 : Typical Characteristics 3) 4) 9) 10) 19) Test Circuit 4 : Typical Characteristics 13) Test Circuit 5 : Typical Characteristics 14) Test Circuit 6 : Typical Characteristics 15) Test Circuit 7 : Typical Characteristics 16) Test Circuit 8 : Typical Characteristics 11) 12) Test Circuit 9 : Typical Characteristics 21) Test Circuit 10 : Typical Characteristics 18) 20)

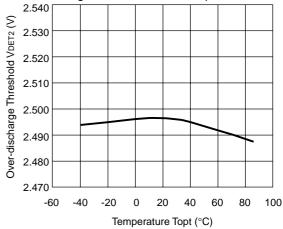
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■ TYPICAL CHARACTERISTICS

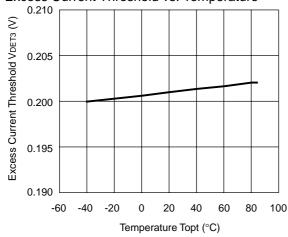
1) Over-charge Threshold vs. Temperature



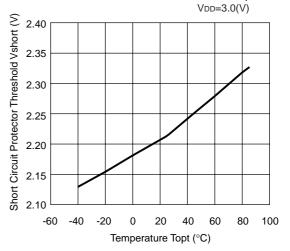
2) Over-discharge Threshold vs. Temperature



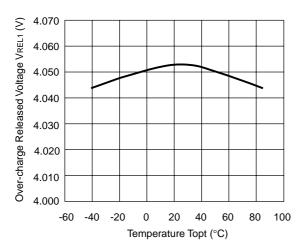
3) Excess Current Threshold vs. Temperature



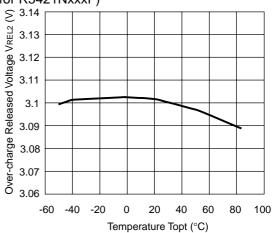
4) Short Circuit Protector Threshold vs. Temperature



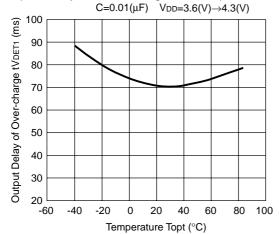
5) Over-charge Released Voltage vs. Temperature



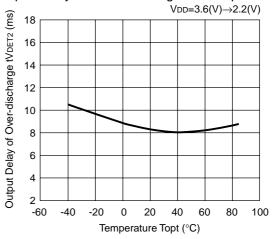
6) Over-discharge Released Voltage vs. Temperature (for R5421NxxxF)



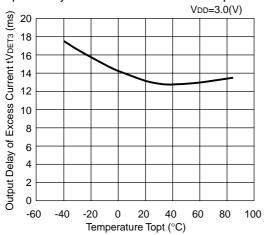
Output Delay of Over-charge vs. Temperature

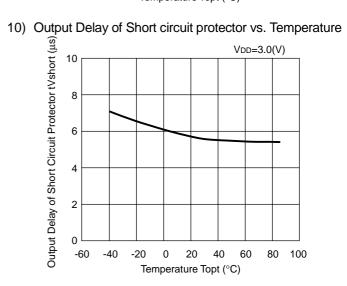


Output Delay of Over-discharge vs. Temperature

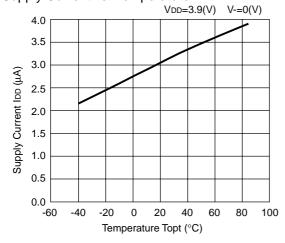


Output delay of Excess current vs. Temperature



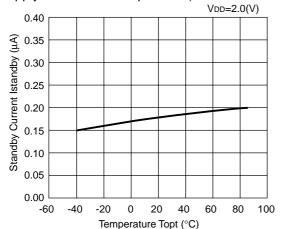


11) Supply Current vs. Temperature

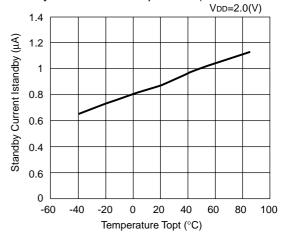


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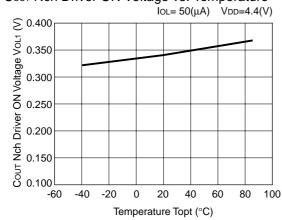
Rev.1.11 - 14 - 12) Supply Current vs. Temperature(for R5421NxxxC)



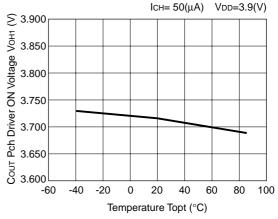
12) Standby Current vs. Temperature(for R5421NxxxF)



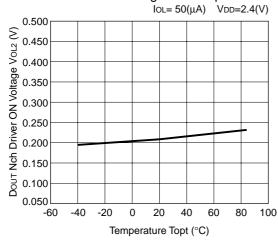
13) Cout Nch Driver ON Voltage vs. Temperature



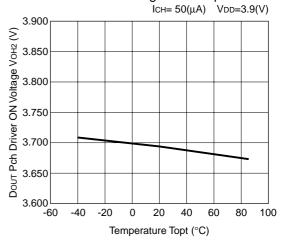
14) Cout Pch Driver ON Voltage vs. Temperature



15) Dout Nch Driver ON Voltage vs. Temperature

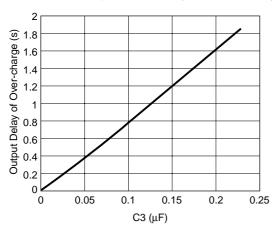


16) Dout Pch Driver ON Voltage vs. Temperature

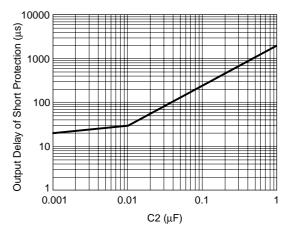


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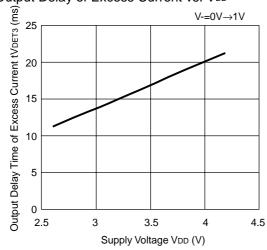
17) Output Delay of Over-charge vs. Capacitance C3 $$V_{DD}=3.8V\to4.3V(R1=100\Omega,\,C1=0.1\mu F,\,R2=1k\Omega,\,C2=0.1\mu F)$$



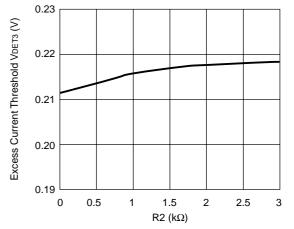
18) Output Delay of Short protection vs. Capacitance C2 $_{R1=100\Omega,~C1=0.1\mu F,~C3=0.01\mu F,~R2=1k\Omega}$



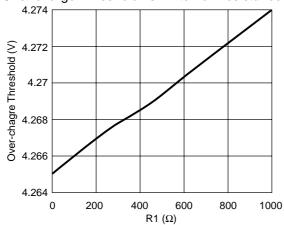
19) Output Delay of Excess Current vs. VDD



20) Excess Current Threshold vs. External Resistance R2

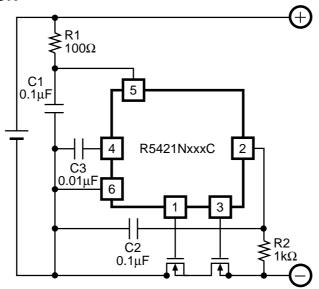


21) Over-charge Threshold vs. External Resistance R1



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■ TYPICAL APPLICATION



■ APPLICATION HINTS

R1 and C1 will stabilize a supply voltage to the R5421NxxxC. A recommended R1 value is less than $1k\Omega$. A larger value of R1 leads higher detection voltage, makes some errors, because of shoot through current flowed in the R5421NxxxC.

R2 and C2 will stabilize a V- pin voltage. The resetting from over-discharge with connecting a charger possibly be disabled by larger value of R2. Recommended value is less than 1 k Ω .

After an over-charge detection even connecting battery pack to a system probably could not allow a system to draw load current by a larger R2C2 time constant in the C version.

Recommended C2 value is less than 1µF.

R1 and R2 can operate also as a part of current limit circuit against for setting cell reverse direction or for applying excess charging voltage to the R5421NxxxC, battery pack, while smaller

R1 and R2 may cause a power consumption over rating of power dissipation of the R5421NxxxC and a total of 'R1+R2' should be more than $1k\Omega$.

The time constants R1C1 or R2C2 must have a relations as below:

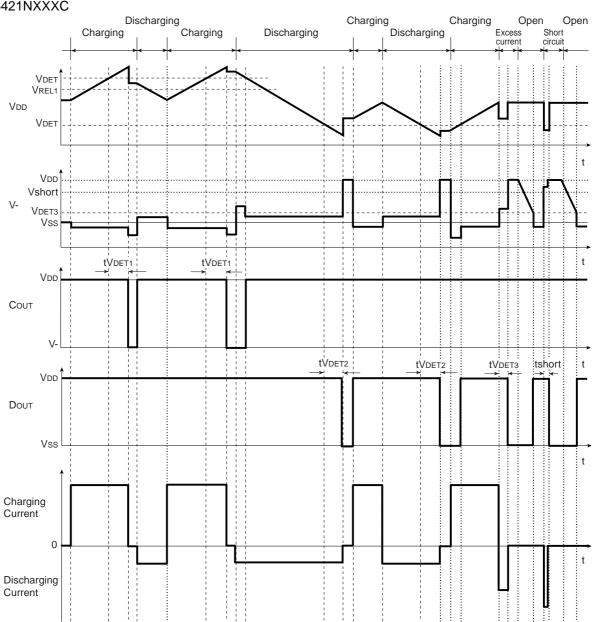
R1C1≤R2C2

Because in case that R1C1, time constant for V_{DD} pin ,would be larger than R2C2, time constant for V- pin, then the R5421NxxxC might be into a standby mode after detecting excess current or short circuit current.

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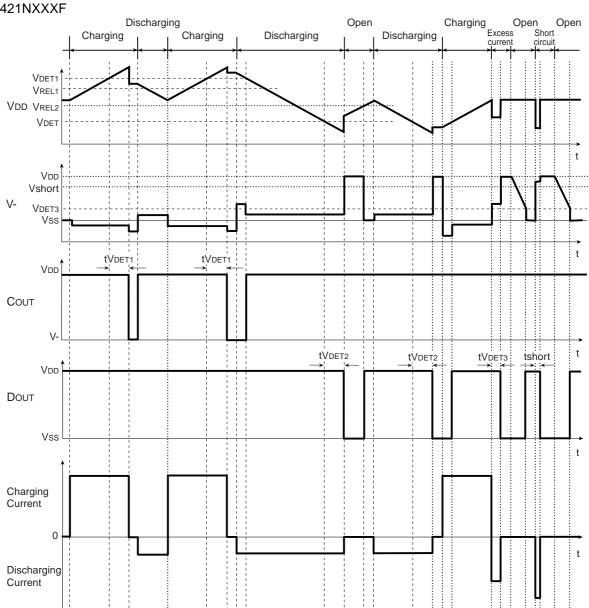
■ TIMING DIAGRAM

R5421NXXXC



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R5421NXXXF



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